

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
ANTTI KERANEN	11/09/2016
JARMO SAASKI	11/14/2016
MIKKO HEIKKINEN	11/14/2016
RECEIVING PARTY DATA	
Name:	TACTOTEK OY
Street Address:	TAKATIE 6
City:	KEMPELE
State/Country:	FINLAND
Postal Code:	FI-90440
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15343731
CORRESPONDENCE DATA	
Fax Number:	(703)685-0573
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	7035212297
Email:	agoode@young-thompson.com
Correspondent Name:	YOUNG & THOMPSON
Address Line 1:	209 MADISON ST., SUITE 500
Address Line 4:	ALEXANDRIA, VIRGINIA 22314
ATTORNEY DOCKET NUMBER:	3502-1515-1
NAME OF SUBMITTER:	ERIC JENSEN
SIGNATURE:	/Eric Jensen/
DATE SIGNED:	02/23/2017
This document serves as an Oath/Declaration (37 CFR 1.63).	
Total Attachments: 1	
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ASSIGNMENT AND INVENTOR'S DECLARATION

WHEREAS I/we, the undersigned inventor(s), hereafter also referred to as "assignor(s)", have invented certain new and useful improvements described in the application identified below; and

WHEREAS, TactoTek Oy, hereinafter referred to as "assignee(s)", whose address is Takatie 6, Kempele, FI-90440 FI, is desirous of acquiring the entire right, title and interest in and to the application and invention, and to any United States patents to be obtained therefor;

NOW, THEREFORE, for valuable consideration, the receipt and sufficiency of which is hereby acknowledged, I/we, the above-named assignor(s), hereby sell, assign and transfer to the above named assignee(s), its successors and assigns, the entire right, title and interest in the application and the invention disclosed therein for the United States of America, including all divisions, and continuations thereof, and all Letters Patent of the United States that may be granted and thereon, all reissues thereof, including any right to bring or maintain an action for infringement under the provisional rights granted pursuant to Title 35, Section 154 of the United States Code or any other cause of action for acts which would constitute infringement occurring prior to this assignment, and including the right to claim priority under the International Convention of Paris (1883), as amended, of or in any corresponding foreign patent application, and I/we request the Director of the U.S. Patent and Trademark Office to issue any Letters Patent granted upon the invention set forth in the application to the assignee(s), its successors and assigns.

As a below named inventor, I hereby declare that:

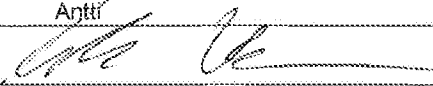
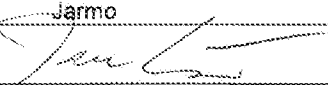
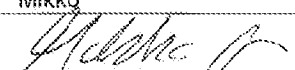
This assignment and declaration is directed to: ☐ The attached application, or
☒ United States Application or PCT International Application Number 15/343,731 filed on November 4, 2016 (Confirmation No 9689).

The application is entitled: **MULTILAYER STRUCTURE AND RELATED METHOD OF MANUFACTURE FOR ELECTRONICS**

The above-identified application was made or was authorized to be made by me.

I believe that I am the original inventor or an original joint inventor of a claimed invention in the application.

I hereby acknowledge that any willful false statement made in this assignment with declaration is punishable under 18 USC 1001 by fine or imprisonment of not more than five (5) years, or both.

Given Name(s)	Antti	Family Name/Surname(s)	KERANEN
Inventor's Signature:		Date	Nov 3rd 2016
Given Name(s)	Jarmo	Family Name/Surname(s)	SAASKI
Inventor's Signature:		Date	Nov 14, 2016
Given Name(s)	Mikko	Family Name/Surname(s)	HEIKKINEN
Inventor's Signature:		Date	14.11.2016.

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RECORDED: 02/23/2017

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